



# 74LVC257A-Q100

Quad 2-input multiplexer with 5 V tolerant inputs/outputs;  
3-state

Rev. 1 — 24 January 2024

Product data sheet

## 1. General description

The 74LVC257A-Q100 is a quad 2-input multiplexer; 3-state. Inputs can be driven from either 3.3 V or 5 V devices. This feature allows the use of these devices as translators in mixed 3.3 V and 5 V environments.

Schmitt-trigger action at all inputs makes the circuit tolerant of slower input rise and fall times.

This device is fully specified for partial power down applications using  $I_{OFF}$ . The  $I_{OFF}$  circuitry disables the output, preventing the potentially damaging backflow current through the device when it is powered down.

This product has been qualified to the Automotive Electronics Council (AEC) standard Q100 (Grade 1) and is suitable for use in automotive applications.

## 2. Features and benefits

- Automotive product qualification in accordance with AEC-Q100 (Grade 1)
  - Specified from -40 °C to +85 °C and from -40 °C to +125 °C
- Overvoltage tolerant inputs to 5.5 V
- Wide supply voltage range from 1.2 V to 3.6 V
- CMOS low-power consumption
- Direct interface with TTL levels
- Output drive capability 50  $\Omega$  transmission lines at 85 °C
- $I_{OFF}$  circuitry provides partial Power-down mode operation
- Complies with JEDEC standard:
  - JESD8-7A (1.65 V to 1.95 V)
  - JESD8-5A (2.3 V to 2.7 V)
  - JESD8-C/JESD36 (2.7 V to 3.6 V)
- ESD protection:
  - HBM: ANSI/ESDA/JEDEC JS-001 class 2 exceeds 2000 V
  - CDM: ANSI/ESDA/JEDEC JS-002 class C3 exceeds 1000 V

## 3. Ordering information

Table 1. Ordering information

Type number	Package			Version
	Temperature range	Name	Description	
<a href="#">74LVC257APW-Q100</a>	-40 °C to +125 °C	TSSOP16	plastic thin shrink small outline package; 16 leads; body width 4.4 mm	<a href="#">SOT403-1</a>

### 4. Functional diagram

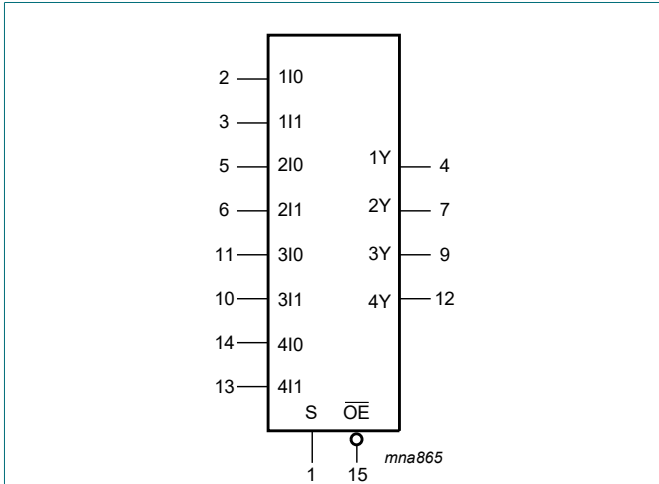


Fig. 1. Logic diagram

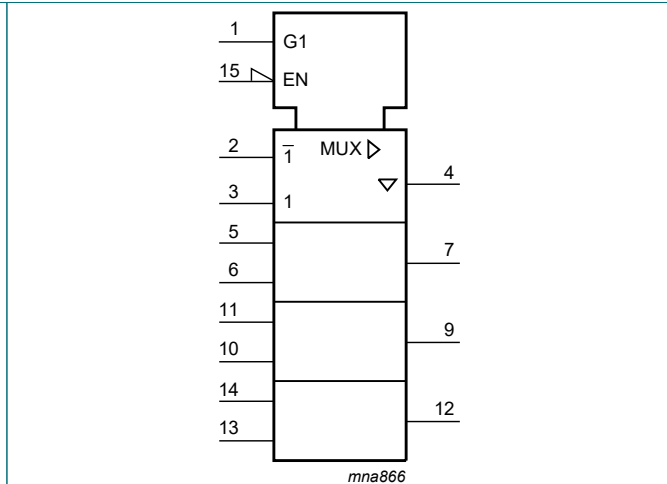


Fig. 2. IEC logic symbol

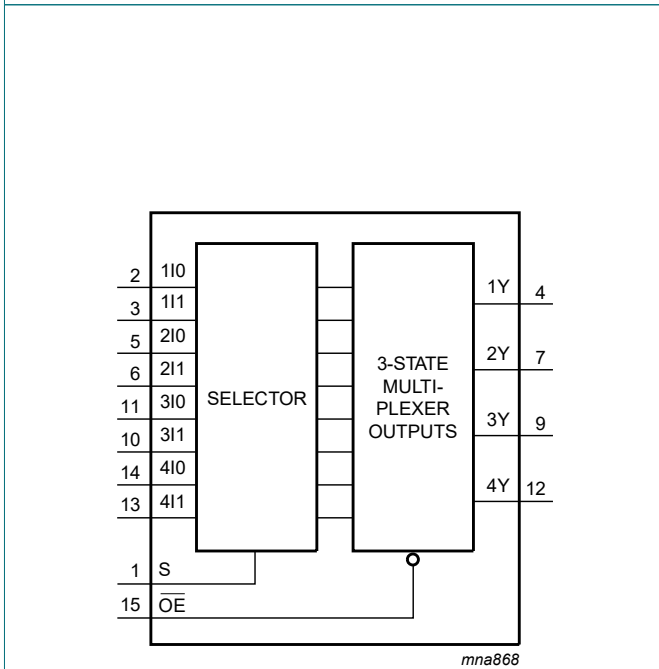


Fig. 3. Functional diagram

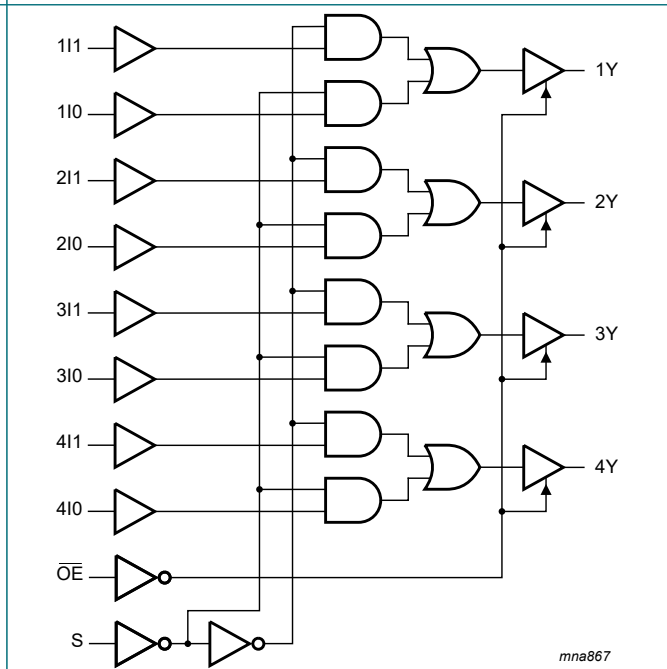
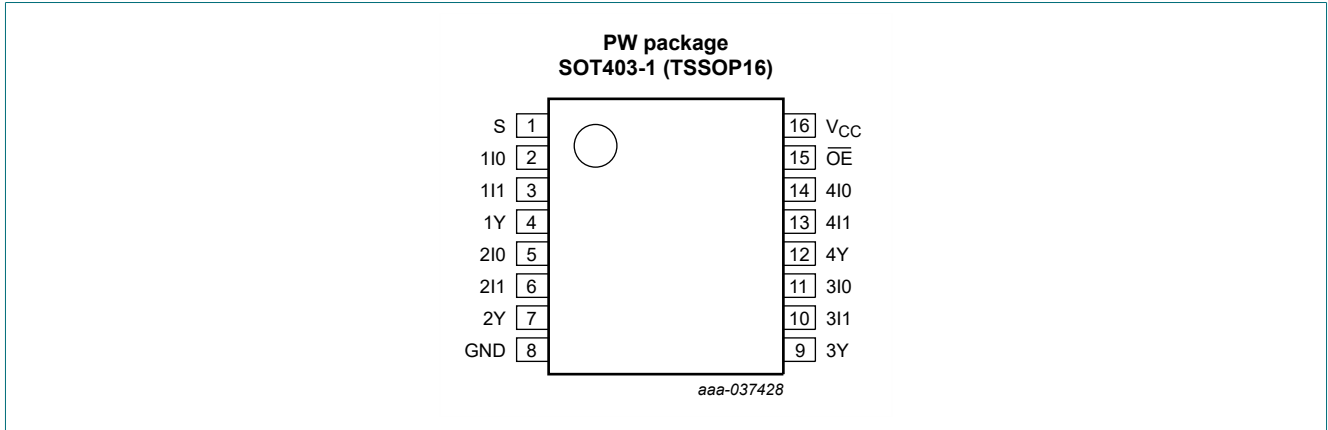


Fig. 4. Logic diagram

## 5. Pinning information

### 5.1. Pinning



### 5.2. Pin description

Table 2. Pin description

Symbol	Pin	Description
S	1	common data select input
1I0, 2I0, 3I0, 4I0	2, 5, 11, 14	data input from source 0
1I1, 2I1, 3I1, 4I1	3, 6, 10, 13	data input from source 1
1Y, 2Y, 3Y, 4Y	4, 7, 9, 12	3-state multiplexer output
GND	8	ground (0 V)
$\overline{OE}$	15	3-state output enable input (active LOW)
V <sub>CC</sub>	16	supply voltage

## 6. Functional description

Table 3. Function table

H = HIGH voltage level; L = LOW voltage level; X = don't care; Z = high-impedance OFF-state

Input				Output
$\overline{OE}$	S	nI0	nI1	nY
H	X	X	X	Z
L	H	X	L	L
L	H	X	H	H
L	L	L	X	L
L	L	H	X	H

## 7. Limiting values

**Table 4. Limiting values**

In accordance with the Absolute Maximum Rating System (IEC 60134). Voltages are referenced to GND (ground = 0 V).

Symbol	Parameter	Conditions	Min	Max	Unit
$V_{CC}$	supply voltage		-0.5	+6.5	V
$I_{IK}$	input clamping current	$V_I < 0$	-50	-	mA
$V_I$	input voltage		[1] -0.5	+6.5	V
$I_{OK}$	output clamping current	$V_O > V_{CC}$ or $V_O < 0$	-	±50	mA
$V_O$	output voltage	HIGH or LOW state	[2] -0.5	$V_{CC} + 0.5$	V
		output 3-state	[2] -0.5	+6.5	V
$I_O$	output current	$V_O = 0$ V to $V_{CC}$	-	±50	mA
$I_{CC}$	supply current		-	100	mA
$I_{GND}$	ground current		-100	-	mA
$T_{stg}$	storage temperature		-65	+150	°C
$P_{tot}$	total power dissipation	$T_{amb} = -40$ °C to +125 °C	[3] -	500	mW

[1] The minimum input voltage ratings may be exceeded if the input current ratings are observed.

[2] The output voltage ratings may be exceeded if the output current ratings are observed.

[3] For SOT403-1 (TSSOP16) package:  $P_{tot}$  derates linearly with 8.5 mW/K above 91 °C.

## 8. Recommended operating conditions

**Table 5. Recommended operating conditions**

Symbol	Parameter	Conditions	Min	Typ	Max	Unit
$V_{CC}$	supply voltage		1.65	-	3.6	V
		functional	1.2	-	-	V
$V_I$	input voltage		0	-	5.5	V
$V_O$	output voltage	HIGH or LOW state	0	-	$V_{CC}$	V
		3-state	0	-	5.5	V
$T_{amb}$	ambient temperature	in free air	-40	-	+125	°C
$\Delta t/\Delta V$	input transition rise and fall rate	$V_{CC} = 1.65$ V to 2.7 V	0	-	20	ns/V
		$V_{CC} = 2.7$ V to 3.6 V	0	-	10	ns/V

## 9. Static characteristics

**Table 6. Static characteristics**

At recommended operating conditions. Voltages are referenced to GND (ground = 0 V).

Symbol	Parameter	Conditions	-40 °C to +85 °C			-40 °C to +125 °C		Unit						
			Min	Typ[1]	Max	Min	Max							
V <sub>IH</sub>	HIGH-level input voltage	V <sub>CC</sub> = 1.2 V	1.08	-	-	1.08	-	V						
		V <sub>CC</sub> = 1.65 V to 1.95 V	0.65V <sub>CC</sub>	-	-	0.65V <sub>CC</sub>	-	V						
		V <sub>CC</sub> = 2.3 V to 2.7 V	1.7	-	-	1.7	-	V						
		V <sub>CC</sub> = 2.7 V to 3.6 V	2.0	-	-	2.0	-	V						
V <sub>IL</sub>	LOW-level input voltage	V <sub>CC</sub> = 1.2 V	-	-	0.12	-	0.12	V						
		V <sub>CC</sub> = 1.65 V to 1.95 V	-	-	0.35V <sub>CC</sub>	-	0.35V <sub>CC</sub>	V						
		V <sub>CC</sub> = 2.3 V to 2.7 V	-	-	0.7	-	0.7	V						
		V <sub>CC</sub> = 2.7 V to 3.6 V	-	-	0.8	-	0.8	V						
V <sub>OH</sub>	HIGH-level output voltage	V <sub>I</sub> = V <sub>IH</sub> or V <sub>IL</sub>												
		I <sub>O</sub> = -100 μA; V <sub>CC</sub> = 1.65 V to 3.6 V	V <sub>CC</sub> - 0.2	-	-	V <sub>CC</sub> - 0.3	-	V						
		I <sub>O</sub> = -4 mA; V <sub>CC</sub> = 1.65 V	1.2	-	-	1.05	-	V						
		I <sub>O</sub> = -8 mA; V <sub>CC</sub> = 2.3 V	1.8	-	-	1.65	-	V						
		I <sub>O</sub> = -12 mA; V <sub>CC</sub> = 2.7 V	2.2	-	-	2.05	-	V						
		I <sub>O</sub> = -18 mA; V <sub>CC</sub> = 3.0 V	2.4	-	-	2.25	-	V						
V <sub>OL</sub>	LOW-level output voltage	V <sub>I</sub> = V <sub>IH</sub> or V <sub>IL</sub>												
		I <sub>O</sub> = 100 μA; V <sub>CC</sub> = 1.65 V to 3.6 V	-	-	0.2	-	0.3	V						
		I <sub>O</sub> = 4 mA; V <sub>CC</sub> = 1.65 V	-	-	0.45	-	0.65	V						
		I <sub>O</sub> = 8 mA; V <sub>CC</sub> = 2.3 V	-	-	0.6	-	0.8	V						
		I <sub>O</sub> = 12 mA; V <sub>CC</sub> = 2.7 V	-	-	0.4	-	0.6	V						
I <sub>I</sub>	input leakage current	V <sub>CC</sub> = 3.6 V; V <sub>I</sub> = 5.5 V or GND	-	±0.1	±5	-	±20	μA						
		I <sub>OZ</sub>	OFF-state output current	V <sub>I</sub> = V <sub>IH</sub> or V <sub>IL</sub> ; V <sub>CC</sub> = 3.6 V; V <sub>O</sub> = 5.5 V or GND	-	±0.1	±5	-	±20	μA				
				I <sub>OFF</sub>	power-off leakage current	V <sub>CC</sub> = 0 V; V <sub>I</sub> or V <sub>O</sub> = 5.5 V	-	±0.1	±10	-	±20	μA		
						I <sub>CC</sub>	supply current	V <sub>CC</sub> = 3.6 V; V <sub>I</sub> = V <sub>CC</sub> or GND; I <sub>O</sub> = 0 A	-	0.1	10	-	40	μA
								ΔI <sub>CC</sub>	additional supply current	per input pin; V <sub>CC</sub> = 2.7 V to 3.6 V; V <sub>I</sub> = V <sub>CC</sub> - 0.6 V; I <sub>O</sub> = 0 A	-	5	500	-
C <sub>I</sub>	input capacitance	V <sub>CC</sub> = 0 V to 3.6 V; V <sub>I</sub> = GND to V <sub>CC</sub>	-	5.0	-	-	-	pF						

[1] All typical values are measured at V<sub>CC</sub> = 3.3 V (unless stated otherwise) and T<sub>amb</sub> = 25 °C.

## 10. Dynamic characteristics

**Table 7. Dynamic characteristics**

Voltages are referenced to GND (ground = 0 V). For test circuit see Fig. 7.

Symbol	Parameter	Conditions	-40 °C to +85 °C			-40 °C to +125 °C		Unit
			Min	Typ[1]	Max	Min	Max	
t <sub>pd</sub>	propagation delay	nI0, nI1 to nY; see Fig. 5 [2]						
		V <sub>CC</sub> = 1.2 V	-	16	-	-	-	ns
		V <sub>CC</sub> = 1.65 V to 1.95 V	1.5	5.2	10.6	1.5	12.3	ns
		V <sub>CC</sub> = 2.3 V to 2.7 V	1.0	2.8	5.5	1.0	6.4	ns
		V <sub>CC</sub> = 2.7 V	1.0	2.8	5.4	1.0	7.0	ns
		V <sub>CC</sub> = 3.0 V to 3.6 V	1.0	2.4	4.6	1.0	6.0	ns
		S to nY; see Fig. 5 [2]						
		V <sub>CC</sub> = 1.2 V	-	18	-	-	-	ns
		V <sub>CC</sub> = 1.65 V to 1.95 V	1.0	6.0	14.8	1.0	17.1	ns
		V <sub>CC</sub> = 2.3 V to 2.7 V	1.0	3.2	7.7	1.0	8.9	ns
		V <sub>CC</sub> = 2.7 V	1.0	3.2	7.5	1.0	9.5	ns
		V <sub>CC</sub> = 3.0 V to 3.6 V	1.0	2.7	6.4	1.0	8.0	ns
t <sub>en</sub>	enable time	OE to nY; see Fig. 6 [2]						
		V <sub>CC</sub> = 1.2 V	-	15	-	-	-	ns
		V <sub>CC</sub> = 1.65 V to 1.95 V	1.5	5.8	12.7	1.5	14.7	ns
		V <sub>CC</sub> = 2.3 V to 2.7 V	1.5	3.3	7.0	1.5	8.1	ns
		V <sub>CC</sub> = 2.7 V	1.5	3.4	6.7	1.5	8.5	ns
		V <sub>CC</sub> = 3.0 V to 3.6 V	1.0	2.7	5.6	1.0	7.0	ns
t <sub>dis</sub>	disable time	OE to nY; see Fig. 6 [2]						
		V <sub>CC</sub> = 1.2 V	-	8	-	-	-	ns
		V <sub>CC</sub> = 1.65 V to 1.95 V	2.2	4.0	8.2	2.2	9.4	ns
		V <sub>CC</sub> = 2.3 V to 2.7 V	0.5	2.2	4.4	0.5	5.1	ns
		V <sub>CC</sub> = 2.7 V	1.5	3.0	4.7	1.5	6.0	ns
		V <sub>CC</sub> = 3.0 V to 3.6 V	1.0	2.8	4.3	1.0	5.5	ns
t <sub>sk(o)</sub>	output skew time	V <sub>CC</sub> = 3.0 V to 3.6 V [3]	-	-	1.0	-	1.5	ns
C <sub>PD</sub>	power dissipation capacitance	per input; V <sub>I</sub> = GND to V <sub>CC</sub> [4]						
		V <sub>CC</sub> = 1.65 V to 1.95 V	-	8.0	-	-	-	pF
		V <sub>CC</sub> = 2.3 V to 2.7 V	-	11.4	-	-	-	pF
		V <sub>CC</sub> = 3.0 V to 3.6 V	-	14.4	-	-	-	pF

[1] Typical values are measured at T<sub>amb</sub> = 25 °C and V<sub>CC</sub> = 1.2 V, 1.8 V, 2.5 V, 2.7 V, and 3.3 V respectively.

[2] t<sub>pd</sub> is the same as t<sub>PLH</sub> and t<sub>PHL</sub>.

t<sub>en</sub> is the same as t<sub>PZL</sub> and t<sub>PZH</sub>.

t<sub>dis</sub> is the same as t<sub>PLZ</sub> and t<sub>PHZ</sub>.

[3] Skew between any two outputs of the same package switching in the same direction. This parameter is guaranteed by design.

[4] C<sub>PD</sub> is used to determine the dynamic power dissipation (P<sub>D</sub> in μW).

$P_D = C_{PD} \times V_{CC}^2 \times f_i \times N + \Sigma(C_L \times V_{CC}^2 \times f_o)$  where:

f<sub>i</sub> = input frequency in MHz; f<sub>o</sub> = output frequency in MHz

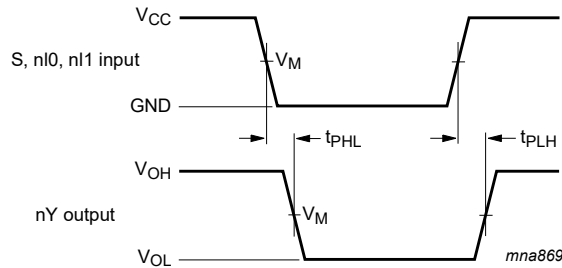
C<sub>L</sub> = output load capacitance in pF

V<sub>CC</sub> = supply voltage in Volt

N = number of inputs switching

$\Sigma(C_L \times V_{CC}^2 \times f_o)$  = sum of the outputs

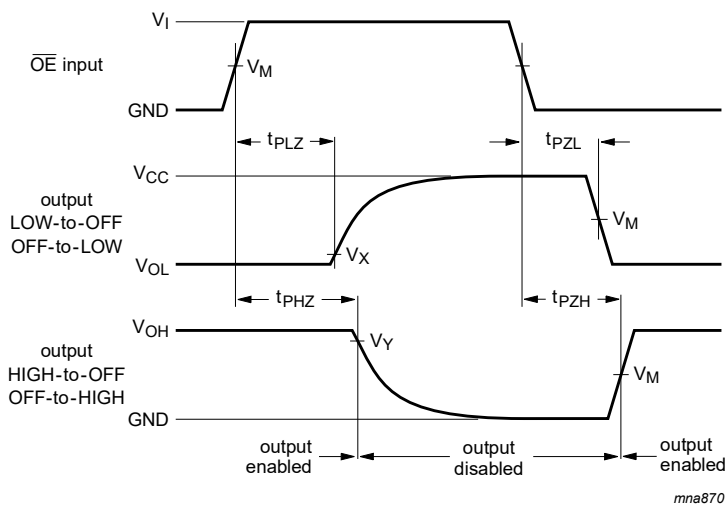
10.1. Waveforms and test circuit



Measurement points are given in [Table 8](#).

$V_{OL}$  and  $V_{OH}$  are typical output voltage levels that occur with the output load.

Fig. 5. Input (S, nI0 and nI1) to output (nY) propagation delays



Measurement points are given in [Table 8](#).

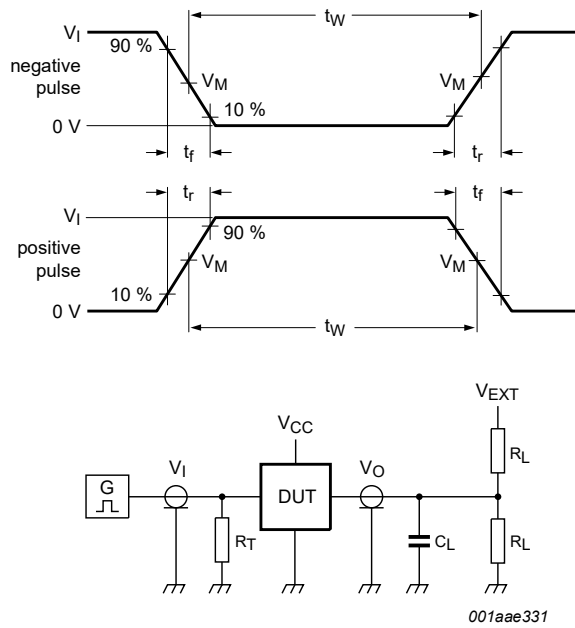
$V_{OL}$  and  $V_{OH}$  are typical output voltage levels that occur with the output load.

Fig. 6. 3-state enable and disable times

Table 8. Measurement points

Supply voltage	Input		Output		
	$V_I$	$V_M$	$V_M$	$V_X$	$V_Y$
1.2 V	$V_{CC}$	$0.5 \times V_{CC}$	$0.5 \times V_{CC}$	$V_{OL} + 0.15 \text{ V}$	$V_{OH} - 0.15 \text{ V}$
1.65 V to 1.95 V	$V_{CC}$	$0.5 \times V_{CC}$	$0.5 \times V_{CC}$	$V_{OL} + 0.15 \text{ V}$	$V_{OH} - 0.15 \text{ V}$
2.3 V to 2.7 V	$V_{CC}$	$0.5 \times V_{CC}$	$0.5 \times V_{CC}$	$V_{OL} + 0.15 \text{ V}$	$V_{OH} - 0.15 \text{ V}$
2.7 V	2.7 V	1.5 V	1.5 V	$V_{OL} + 0.3 \text{ V}$	$V_{OH} - 0.3 \text{ V}$
3.0 V to 3.6 V	2.7 V	1.5 V	1.5 V	$V_{OL} + 0.3 \text{ V}$	$V_{OH} - 0.3 \text{ V}$

Quad 2-input multiplexer with 5 V tolerant inputs/outputs; 3-state



Test data is given in [Table 9](#).

Definitions for test circuit:

$R_L$  = Load resistance;

$C_L$  = Load capacitance including jig and probe capacitance;

$R_T$  = Termination resistance should be equal to output impedance  $Z_o$  of the pulse generator;

$V_{EXT}$  = External voltage for measuring switching times.

**Fig. 7. Test circuit for measuring switching times**

**Table 9. Test data**

Supply voltage	Input		Load		$V_{EXT}$		
	$V_I$	$t_r, t_f$	$C_L$	$R_L$	$t_{PLH}, t_{PHL}$	$t_{PLZ}, t_{PZL}$	$t_{PHZ}, t_{PZH}$
1.2 V	$V_{CC}$	$\leq 2$ ns	30 pF	1 k $\Omega$	open	$2 \times V_{CC}$	GND
1.65 V to 1.95 V	$V_{CC}$	$\leq 2$ ns	30 pF	1 k $\Omega$	open	$2 \times V_{CC}$	GND
2.3 V to 2.7 V	$V_{CC}$	$\leq 2$ ns	30 pF	500 $\Omega$	open	$2 \times V_{CC}$	GND
2.7 V	2.7 V	$\leq 2.5$ ns	50 pF	500 $\Omega$	open	$2 \times V_{CC}$	GND
3.0 V to 3.6 V	2.7 V	$\leq 2.5$ ns	50 pF	500 $\Omega$	open	$2 \times V_{CC}$	GND



### 11. Package outline

TSSOP16: plastic thin shrink small outline package; 16 leads; body width 4.4 mm

SOT403-1

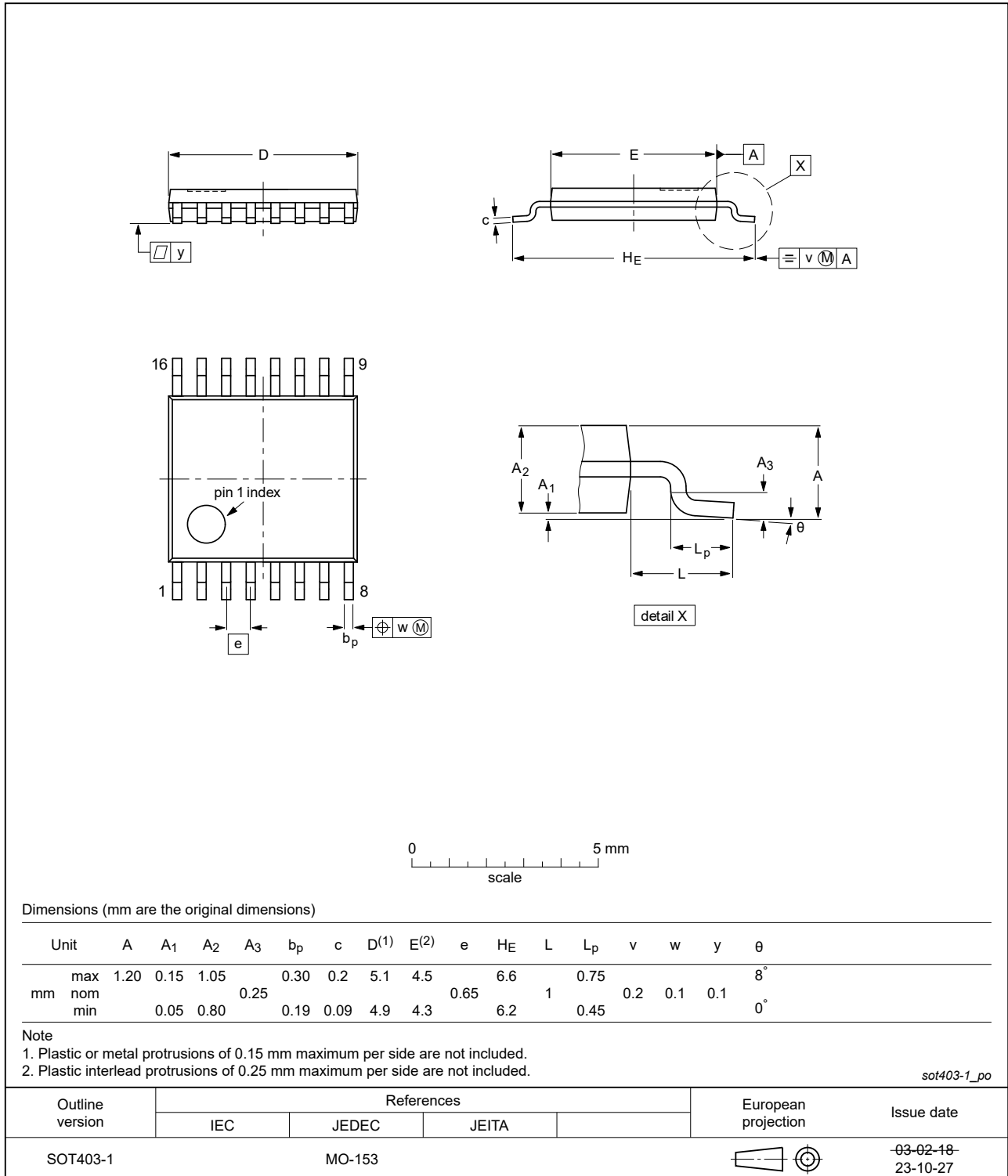


Fig. 8. Package outline SOT403-1 (TSSOP16)

## 12. Abbreviations

Table 10. Abbreviations

Acronym	Description
CDM	Charged Device Model
CMOS	Complementary Metal-Oxide Semiconductor
DUT	Device Under Test
ESD	ElectroStatic Discharge
HBM	Human Body Model
TTL	Transistor-Transistor Logic

## 13. Revision history

Table 11. Revision history

Document ID	Release date	Data sheet status	Change notice	Supersedes
74LVC257A_Q100 v.1	20240124	Product data sheet	-	-

## 14. Legal information

### Data sheet status

Document status [1][2]	Product status [3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
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